

COMBINED DECLARATION AND POWER OF ATTORNEY FOR UTILITY PATENT APPLICATION (Includes PCT)

Attorney Docket No.
1928/71711-2/8

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

LEAD FRAME FOR AN INTEGRATED CIRCUIT CHIP (SMALL WINDOW)

the specification of which (check one): ☒ is attached hereto.

☐ was filed on _____ as Application Serial No. _____ and was amended on _____.

☐ was filed as PCT international application no. _____ on _____, and was amended under PCT Article 19 on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I do not know and do not believe the claimed invention was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application.

I hereby claim foreign priority benefits under Title 35, United States Code §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application(s) on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

<u>9900055-6</u> (Number)	<u>Singapore</u> (Country)	<u>9 Feb. 1999</u> Day/Month/Year Filed	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ Day/Month/Year Filed	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ Day/Month/Year Filed	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, §119 (e) of any United States provisional application(s) listed below:

_____ Application No.	_____ Day/Month/Year Filed	_____ Application No.	_____ Day/Month/Year Filed
--------------------------	-------------------------------	--------------------------	-------------------------------

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.

Filing Date

Status (patented, pending, abandoned)

Application Serial No.


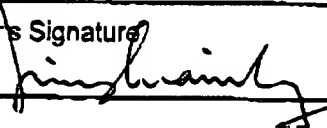

Filing Date

Status (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith; Watson Cole Grindle Watson, P.L.L.C.; Lawrence R. Radanovic, Reg. No. 23,077; Richard H. Tushin, Reg. No. 27,297; Donald N. Huff, Reg. No. 27,561; John P. DeLuca, Reg. No. 25,505; Michael Bergman, Reg. No. 42,318; Walter D. Ames, Reg. No. 17,913 and Roy W. Butrum, Reg. No. 18,290. Direct all telephone calls to telephone no. (202) 628-3600 and faxes to (202) 628-3650.

Address all correspondence to Watson Cole Grindle Watson, P.L.L.C., 10th Floor, 1400 K Street, N.W., Washington, D.C. 20005-2477.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Sole, First Inventor Tai Chong CHAI	Inventor's Signature X 	Date X 18/11/99
Residence: Blk, 13 St. George's Road, #03-262 Singapore 320013		Citizenship Malaysia
Post Office Address: Same as the above		
Full Name of Second, Joint Inventor Thiam Beng LIM	Inventor's Signature X 	Date X 19/11/99
Residence: 46 Toh Crescent Singapore 507957		Citizenship Singapore
Post Office Address: Same as the above		
Full Name of Third, Joint Inventor Yong Chua TEO	Inventor's Signature X 	Date X 18/11/99
Residence: Blk 133 Geylang East Ave 1, #04-207 Singapore 3870133		Citizenship Singapore
Post Office Address: Same as the above		

Full Name of Fourth, Joint Inventor James TAN	Inventor's Signature <i>James Tan</i>	Date x 4/1/2000
Residence: Blk 204 Toa Payoh North, #19-1131 Singapore 310204		Citizenship Singapore
Post Office Address: Same as the above		
Full Name of Fifth, Joint Inventor Raymundo CAMENFORTE Raymundo	Inventor's Signature <i>Raymundo Camenforte</i>	Date x 17/01/2000
Residence: Blk 692 Jurong West Central 1, #10-63 Singapore 640692		Citizenship Philippines
Post Office Address: Same as the above		
Full Name of Sixth, Joint Inventor Eric NEO	Inventor's Signature <i>Eric Neo</i>	Date x 11 Jan 2000
Residence: Blk 222 Ang Mo Kio, #09-723 Singapore 560222		Citizenship Singapore
Post Office Address: Same as the above		
Full Name of Seventh, Joint Inventor Daniel YAP	Inventor's Signature <i>Daniel Yap</i>	Date x 27/1/2000
Residence: Blk 43, Jin Bahagia, #01-134 Singapore 320043		Citizenship Singapore
Post Office Address: Same as the above		